



P96/P26

Isola offers a product line of polyimide-based prepreg (P26) and core material (P96) for high temperature printed circuit applications.

These products consist of a flame resistant, polyimide resin system suitable for military, commercial or industrial electronic applications requiring superior performance and the utmost in thermal properties. These products utilize a polyimide and thermoplastic blend resin, fully cured without the use of MDA (Methylenedianiline). This results in a polymer with a high Tg without the characteristic difficulties of brittleness and low initial bond strength associated with traditional thermoset polyimides.

ORDERING INFORMATION:

Contact your local sales representative or visit www.isola-group.com for further information.

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Performance

Tg 260°C

Td 396°C

Dk 3.76

Df 0.017

zIPC- 4101C /21 /24 /26 /98 /101 /126

UL - File Number E41625

Qualified to UL's MCIL Program

Product Features

- Industry Recognition
 - UL File Number: E41625
 - RoHS Compliant
- Performance Attributes
- Processing Advantages

Product Availability

- Standard Material Offering: Laminate
 - 2 to 125 mil (0.05 to 3.2 mm)
 - Available in full size sheet or panel form
- Copper Foil Type
 - HTE Grade 3
 - RTF (Reverse Treat Foil)
- Copper Weight
 - ½ to 2 oz (18 to 70 µm) available
 - Heavier copper available
 - Thinner copper foil available
- Standard Material Offering: Prepreg
 - Roll or panel form
 - Tooling of prepreg panels
- Glass Fabric Availability
 - E-glass

P96/P26 Specifications

Property		Typical Value	Units	Test Method
			Metric (English)	IPC-TM-650 (or as noted)
Glass Transition Temperature (Tg) by DSC		260	°C	2.4.25
Decomposition Temperature (Td) by TGA @ 5% weight loss		396	°C	2.4.24.2
Time to Delaminate by TMA (Copper removed)	A. T260 B. T288	60	Minutes	2.4.24.1
Z-Axis CTE	A. Pre-Tg B. 50 to 260°C, (Total Expansion)	55 1.5	ppm/°C %	2.4.24
X/Y-Axis CTE	Pre-Tg	13/14	ppm/°C	2.4.24.1
Thermal Conductivity		0.4	W/mK	ASTM E1952
Thermal Stress 10 sec @ 288°C (550.4°F)	A. Unetched B. Etched	Pass	Pass Visual	2.4.13.1
Dk, Permittivity	A. @ 100 MHz	3.83	—	2.5.5.9
	B. @ 500 MHz	3.80		2.5.5.9
	C. @ 1 GHz	3.78		2.5.5.9
	D. @ 2 GHz	3.76		Bereskin Stripline
	E. @ 5 GHz	3.73		Bereskin Stripline
	F. @ 10 GHz	3.73		Bereskin Stripline
Df, Loss Tangent	A. @ 100 MHz	0.0135	—	2.5.5.9
	B. @ 500 MHz	0.0151		2.5.5.9
	C. @ 1 GHz	0.0172		2.5.5.9
	D. @ 2 GHz	0.0179		Bereskin Stripline
	E. @ 5 GHz	0.0188		Bereskin Stripline
	F. @ 10 GHz	0.021		Bereskin Stripline
Volume Resistivity	A. After moisture resistance B. At elevated temperature	3.0 x 10 ⁸ 7.0 x 10 ⁸	MΩ-cm	2.5.17.1
Surface Resistivity	A. After moisture resistance B. At elevated temperature	3 x 10 ⁶ 2 x 10 ⁸	MΩ	2.5.17.1
Dielectric Breakdown		>55	kV	2.5.6
Arc Resistance		130	Seconds	2.5.1
Electric Strength (Laminate & laminated prepreg)		44 (1100)	kV/mm (V/mil)	2.5.6.2
Comparative Tracking Index (CTI)		4 (100-174)	Class (Volts)	UL 746A ASTM D3638
Peel Strength	A. Low profile copper foil and very low profile copper foil all copper foil >17 μm [0.669 mil]	1.14 (6.5)	N/mm (lb/inch)	2.4.8
	B. Standard profile copper	1.25 (7.0)		2.4.8.2
	1. After thermal stress	1.25 (7.0)		2.4.8.3
	2. At 125°C (257°F)	1.14 (6.5)		2.4.8.3
Flexural Strength	A. Length direction	83,600	lb/inch ²	2.4.4
	B. Cross direction	55,500		
Tensile Strength	A. Length direction	55,000	lb/inch ²	ASTM D3039
	B. Cross direction	35,370		
Poisson's Ratio	A. Length direction	0.189	—	ASTM D3039
	B. Cross direction	0.154		
Moisture Absorption		0.5	%	2.6.2.1
Flammability (Laminate & laminated prepreg)		V-0	Rating	UL 94
Max Operating Temperature		130	°C	UL 796

The data, while believed to be accurate and based on analytical methods considered to be reliable, is for information purposes only. Any sales of these products will be governed by the terms and conditions of the agreement under which they are sold.

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